

# DATA SHEET

## **TDA8771A**

Triple 8-bit video Digital-to-Analog  
Converter (DAC)

Product specification  
File under Integrated Circuits, IC02

1996 Jan 25

## Triple 8-bit video Digital-to-Analog Converter (DAC)

## TDA8771A

### FEATURES

- 8-bit resolution
- Sampling rate up to 35 MHz
- Internal reference voltage regulator
- No deglitching circuit required
- Large output voltage range
- 1 k $\Omega$  output load
- Power dissipation only 200 mW
- Single 5 V power supply
- 44-pin QFP package.

### GENERAL DESCRIPTION

The TDA8771A is a triple 8-bit video Digital-to-Analog Converter (DAC). It converts the digital input signals into analog voltage outputs at a maximum conversion rate of 35 MHz.

The DACs are based on resistor-string architecture with integrated output buffers. The output voltage range is determined by a built-in reference source.

The device is fabricated in a 5 V, CMOS process that ensures high functionality with low power dissipation.

### APPLICATIONS

- General purpose high-speed digital-to-analog conversion
- Digital TV
- Graphic display
- Desktop video processing.

### QUICK REFERENCE DATA

| SYMBOL                | PARAMETER                  | CONDITIONS                                                        | MIN. | TYP.  | MAX. | UNIT |
|-----------------------|----------------------------|-------------------------------------------------------------------|------|-------|------|------|
| V <sub>DDA</sub>      | analog supply voltage      |                                                                   | 4.5  | 5.0   | 5.5  | V    |
| V <sub>DDD</sub>      | digital supply voltage     |                                                                   | 4.5  | 5.0   | 5.5  | V    |
| I <sub>DDA</sub>      | analog supply current      | R <sub>L</sub> = 1 k $\Omega$ ; note 1                            | 10   | 33    | 45   | mA   |
| I <sub>DDD</sub>      | digital supply current     | f <sub>clk</sub> = 35 MHz                                         | –    | 7     | 20   | mA   |
| INL                   | integral non-linearity     | f <sub>clk</sub> = 35 MHz; ramp input                             | –    | ±0.5  | ±1   | LSB  |
| DNL                   | differential non-linearity | f <sub>clk</sub> = 35 MHz; ramp input                             | –    | ±0.25 | ±0.5 | LSB  |
| f <sub>clk(max)</sub> | maximum clock frequency    |                                                                   | 35   | –     | –    | MHz  |
| P <sub>tot</sub>      | total power dissipation    | R <sub>L</sub> = 1 k $\Omega$ ; f <sub>clk</sub> = 35 MHz; note 1 | 45   | 200   | 360  | mW   |

### Note

1. Minimum and maximum data of current and power consumption are measured in worse case conditions: for minimum data, all digital inputs are at logic level 0 while for maximum data, all digital inputs are at logic level 1.

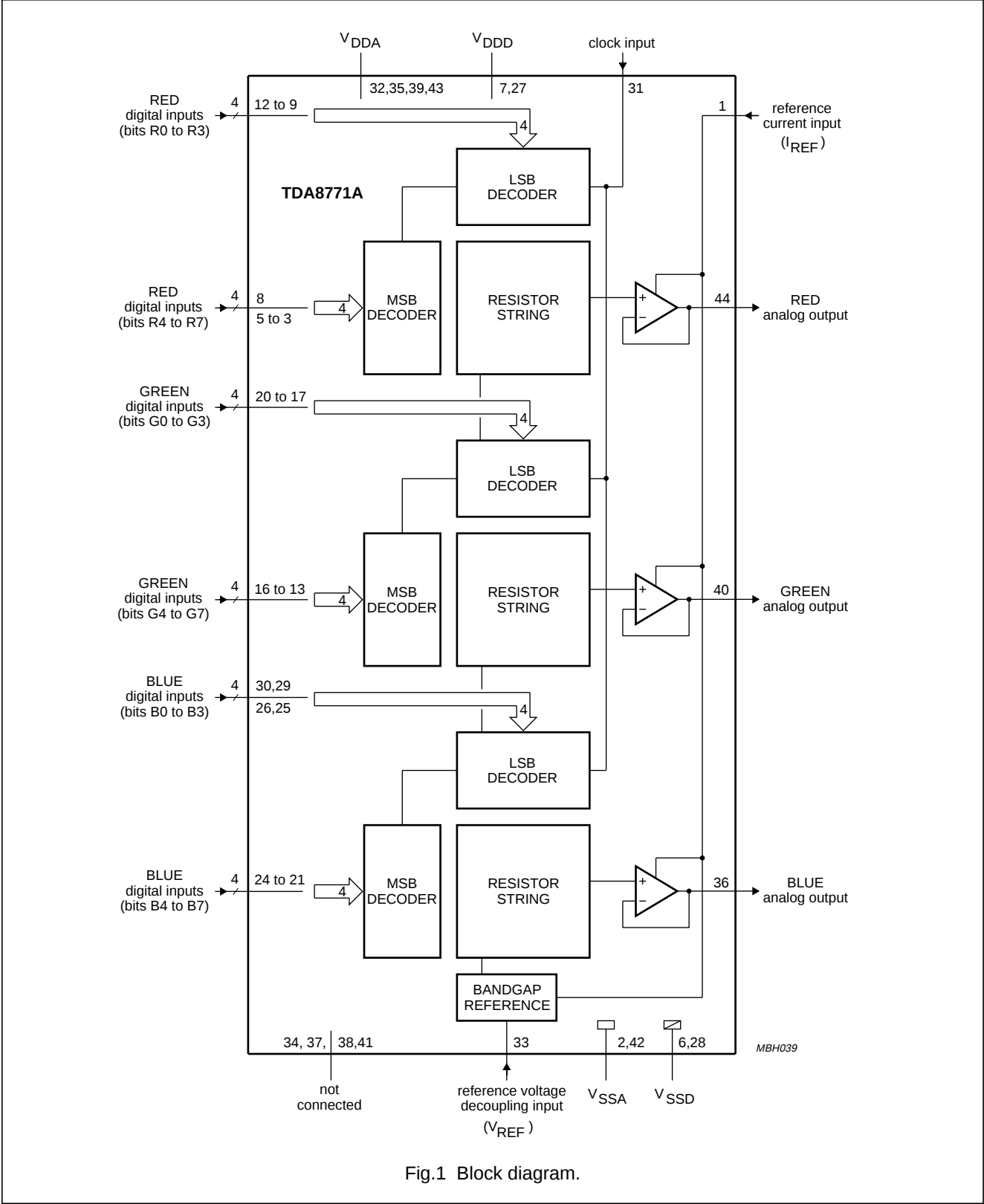
### ORDERING INFORMATION

| TYPE NUMBER | PACKAGE |                                                                                  |          |
|-------------|---------|----------------------------------------------------------------------------------|----------|
|             | NAME    | DESCRIPTION                                                                      | VERSION  |
| TDA8771AH   | QFP44   | plastic quad flat package; 44 leads (lead length 1.3 mm); body 10 × 10 × 1.75 mm | SOT307-2 |

Triple 8-bit video Digital-to-Analog Converter (DAC)

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BLOCK DIAGRAM



# Triple 8-bit video Digital-to-Analog Converter (DAC)

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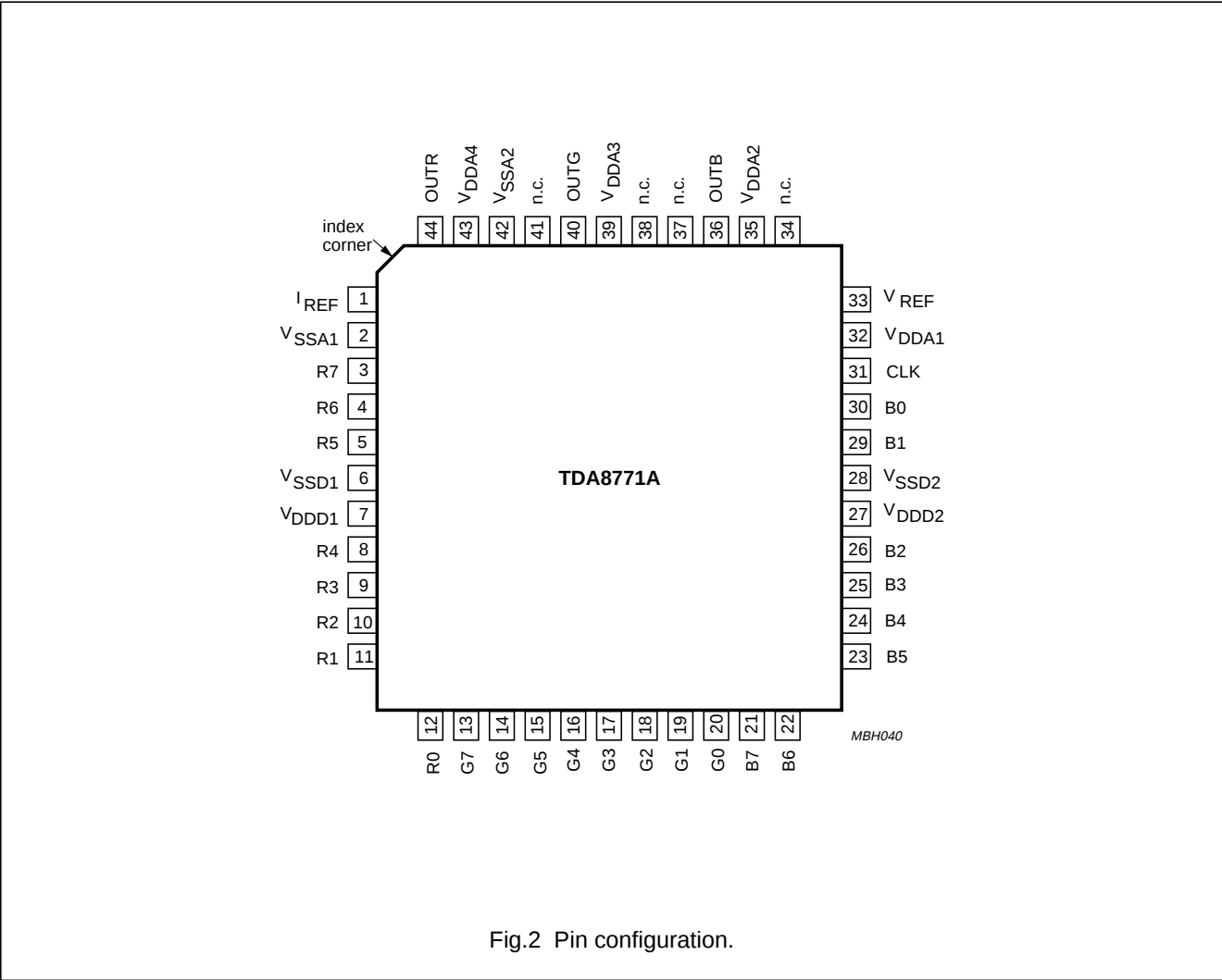
## PINNING

| SYMBOL            | PIN | DESCRIPTION                                |
|-------------------|-----|--------------------------------------------|
| I <sub>REF</sub>  | 1   | reference current input for output buffers |
| V <sub>SSA1</sub> | 2   | analog supply ground 1                     |
| R7                | 3   | RED digital input data; bit 7 (MSB)        |
| R6                | 4   | RED digital input data; bit 6              |
| R5                | 5   | RED digital input data; bit 5              |
| V <sub>SSD1</sub> | 6   | digital supply ground 1                    |
| V <sub>DDD1</sub> | 7   | digital supply voltage 1                   |
| R4                | 8   | RED digital input data; bit 4              |
| R3                | 9   | RED digital input data; bit 3              |
| R2                | 10  | RED digital input data; bit 2              |
| R1                | 11  | RED digital input data; bit 1              |
| R0                | 12  | RED digital input data; bit 0 (LSB)        |
| G7                | 13  | GREEN digital input data; bit 7 (MSB)      |
| G6                | 14  | GREEN digital input data; bit 6            |
| G5                | 15  | GREEN digital input data; bit 5            |
| G4                | 16  | GREEN digital input data; bit 4            |
| G3                | 17  | GREEN digital input data; bit 3            |
| G2                | 18  | GREEN digital input data; bit 2            |
| G1                | 19  | GREEN digital input data; bit 1            |
| G0                | 20  | GREEN digital input data; bit 0 (LSB)      |
| B7                | 21  | BLUE digital input data; bit 7 (MSB)       |
| B6                | 22  | BLUE digital input data; bit 6             |
| B5                | 23  | BLUE digital input data; bit 5             |
| B4                | 24  | BLUE digital input data; bit 4             |
| B3                | 25  | BLUE digital input data; bit 3             |
| B2                | 26  | BLUE digital input data; bit 2             |
| V <sub>DDD2</sub> | 27  | digital supply voltage 2                   |
| V <sub>SSD2</sub> | 28  | digital supply ground 2                    |
| B1                | 29  | BLUE digital input data; bit 1             |
| B0                | 30  | BLUE digital input data; bit 0 (LSB)       |
| CLK               | 31  | clock input                                |
| V <sub>DDA1</sub> | 32  | analog supply voltage 1                    |
| V <sub>REF</sub>  | 33  | decoupling input for reference voltage     |
| n.c.              | 34  | not connected                              |
| V <sub>DDA2</sub> | 35  | analog supply voltage 2                    |
| OUTB              | 36  | BLUE analog output                         |
| n.c.              | 37  | not connected                              |
| n.c.              | 38  | not connected                              |
| V <sub>DDA3</sub> | 39  | analog supply voltage 3                    |
| OUTG              | 40  | GREEN analog output                        |

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| SYMBOL            | PIN | DESCRIPTION             |
|-------------------|-----|-------------------------|
| n.c.              | 41  | not connected           |
| V <sub>SSA2</sub> | 42  | analog supply ground 2  |
| V <sub>DDA4</sub> | 43  | analog supply voltage 4 |
| OUTR              | 44  | RED analog output       |



# Triple 8-bit video Digital-to-Analog Converter (DAC)

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## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC134).

| SYMBOL          | PARAMETER                                                 | MIN. | MAX. | UNIT |
|-----------------|-----------------------------------------------------------|------|------|------|
| $V_{DDA}$       | analog supply voltage                                     | −0.5 | +6.5 | V    |
| $V_{DDD}$       | digital supply voltage                                    | −0.5 | +6.5 | V    |
| $\Delta V_{DD}$ | supply voltage difference between $V_{DDA}$ and $V_{DDD}$ | −1.0 | +1.0 | V    |
| $T_{stg}$       | storage temperature                                       | −55  | +150 | °C   |
| $T_{amb}$       | operating ambient temperature                             | 0    | +70  | °C   |
| $T_j$           | junction temperature                                      | −    | +125 | °C   |

## THERMAL CHARACTERISTICS

| SYMBOL        | PARAMETER                                               | VALUE | UNIT |
|---------------|---------------------------------------------------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient in free air | 75    | K/W  |

## HANDLING

Inputs and outputs are protected against electrostatic discharges in normal handling. However, to be totally safe, it is desirable to take normal precautions appropriate to handling integrated circuits.

# Triple 8-bit video Digital-to-Analog Converter (DAC)

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## CHARACTERISTICS

$V_{DDA} = V_{DDD} = 4.5$  to  $5.5$  V;  $V_{SSA}$  and  $V_{SSD}$  shorted together;  $V_{DDA} - V_{DDD} = -0.5$  to  $+0.5$  V;  $T_{amb} = 0$  to  $70$  °C; typical values measured at  $V_{DDA} = V_{DDD} = 5$  V and  $T_{amb} = 25$  °C; unless otherwise specified.

| SYMBOL                                                                                                            | PARAMETER                       | CONDITIONS                              | MIN.  | TYP.  | MAX.      | UNIT       |
|-------------------------------------------------------------------------------------------------------------------|---------------------------------|-----------------------------------------|-------|-------|-----------|------------|
| <b>Supply</b>                                                                                                     |                                 |                                         |       |       |           |            |
| $V_{DDA}$                                                                                                         | analog supply voltage           |                                         | 4.5   | 5.0   | 5.5       | V          |
| $V_{DDD}$                                                                                                         | digital supply voltage          |                                         | 4.5   | 5.0   | 5.5       | V          |
| $I_{DDA}$                                                                                                         | analog supply current           | $R_L = 1$ k $\Omega$ ; note 1           | 10    | 33    | 45        | mA         |
| $I_{DDD}$                                                                                                         | digital supply current          | $f_{clk} = 35$ MHz                      | –     | 7     | 20        | mA         |
| <b>Inputs</b>                                                                                                     |                                 |                                         |       |       |           |            |
| CLOCK INPUT (PIN 31)                                                                                              |                                 |                                         |       |       |           |            |
| $V_{IL}$                                                                                                          | LOW level input voltage         |                                         | 0     | –     | 1.2       | V          |
| $V_{IH}$                                                                                                          | HIGH level input voltage        |                                         | 2.0   | –     | $V_{DDD}$ | V          |
| R, G, B DIGITAL INPUTS (PINS 12 TO 8, 5 TO 3, 20 TO 13, 30, 29 AND 26 TO 21)                                      |                                 |                                         |       |       |           |            |
| $V_{IL}$                                                                                                          | LOW level input voltage         |                                         | 0     | –     | 1.2       | V          |
| $V_{IH}$                                                                                                          | HIGH level input voltage        |                                         | 2.0   | –     | $V_{DDD}$ | V          |
| $I_{REF}$ REFERENCE CURRENT INPUT FOR OUTPUT BUFFERS (PIN 1)                                                      |                                 |                                         |       |       |           |            |
| $I_I$                                                                                                             | input current                   |                                         | –     | 0.6   | 0.7       | mA         |
| <b>Timing; see Fig.3</b>                                                                                          |                                 |                                         |       |       |           |            |
| $f_{clk(max)}$                                                                                                    | maximum clock frequency         |                                         | 35    | –     | –         | MHz        |
| $t_{CPH}$                                                                                                         | clock pulse width HIGH          |                                         | 8     | –     | –         | ns         |
| $t_{CPL}$                                                                                                         | clock pulse width LOW           |                                         | 8     | –     | –         | ns         |
| $t_r$                                                                                                             | clock rise time                 |                                         | –     | –     | 5         | ns         |
| $t_f$                                                                                                             | clock fall time                 |                                         | –     | –     | 6         | ns         |
| $t_{SU;DAT}$                                                                                                      | input data set-up time          |                                         | 4     | –     | –         | ns         |
| $t_{HD;DAT}$                                                                                                      | input data hold time            |                                         | 4     | –     | –         | ns         |
| <b>Voltage reference (pin 33, referenced to <math>V_{SSA}</math>)</b>                                             |                                 |                                         |       |       |           |            |
| $V_{REF}$                                                                                                         | output reference voltage        |                                         | 1.180 | 1.242 | 1.305     | V          |
| <b>Outputs</b>                                                                                                    |                                 |                                         |       |       |           |            |
| OUTB, OUTR, OUTG ANALOG OUTPUTS (PINS 36, 44 AND 40, REFERENCED TO $V_{SSA}$ ) FOR 1 k $\Omega$ LOAD; see Table 1 |                                 |                                         |       |       |           |            |
| FSR                                                                                                               | full-scale output voltage range |                                         | 2.80  | 2.95  | 3.10      | V          |
| $V_{os}$                                                                                                          | offset of analog voltage output |                                         | –     | 0.25  | –         | V          |
| $V_{Omax}$                                                                                                        | maximum output voltage          | data inputs = logic 1; note 2           | 2.95  | 3.20  | 3.45      | V          |
| $V_{Omin}$                                                                                                        | minimum output voltage          | data inputs = logic 0; note 2           | 0.05  | 0.25  | 0.45      | V          |
| THD                                                                                                               | total harmonic distortion       | $f_i = 4.43$ MHz;<br>$f_{clk} = 35$ MHz | –     | –44   | –         | dB         |
| $Z_L$                                                                                                             | output load impedance           |                                         | 0.9   | 1.0   | 1.1       | k $\Omega$ |

# Triple 8-bit video Digital-to-Analog Converter (DAC)

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| SYMBOL                                                                               | PARAMETER                      | CONDITIONS                      | MIN. | TYP. | MAX.      | UNIT   |
|--------------------------------------------------------------------------------------|--------------------------------|---------------------------------|------|------|-----------|--------|
| <b>Transfer function (<math>f_{\text{clk}} = 35 \text{ MHz}</math>)</b>              |                                |                                 |      |      |           |        |
| INL                                                                                  | integral non-linearity         | ramp input                      | –    | 0.5  | $\pm 1$   | LSB    |
| DNL                                                                                  | differential non-linearity     | ramp input                      | –    | 0.25 | $\pm 0.5$ | LSB    |
| $\alpha_{\text{ct}}$                                                                 | crosstalk DAC to DAC           |                                 | –50  | –    | –         | dB     |
|                                                                                      | DAC to DAC matching            |                                 | –    | 1.0  | 2.0       | %      |
| <b>Switching characteristics (for 1 k<math>\Omega</math> output load); see Fig.4</b> |                                |                                 |      |      |           |        |
| $t_d$                                                                                | input to 50% output delay time | full-scale change               | –    | 12   | –         | ns     |
| $t_{s1}$                                                                             | settling time                  | 10% to 90% of full-scale change | –    | 15   | –         | ns     |
| $t_{s2}$                                                                             | settling time                  | to $\pm 1$ LSB                  | –    | 50   | –         | ns     |
| <b>Output transients (glitches)</b>                                                  |                                |                                 |      |      |           |        |
| $V_g$                                                                                | area for 1 LSB change          |                                 | –    | 1    | –         | LSB·ns |

## Notes

1. Minimum and maximum data of current and power consumption are measured in worse case conditions: for minimum data, all digital inputs are at logic level 0 while for maximum data, all digital inputs are at logic level 1.
2.  $V_O$  is directly proportional to  $V_{\text{REF}}$ .

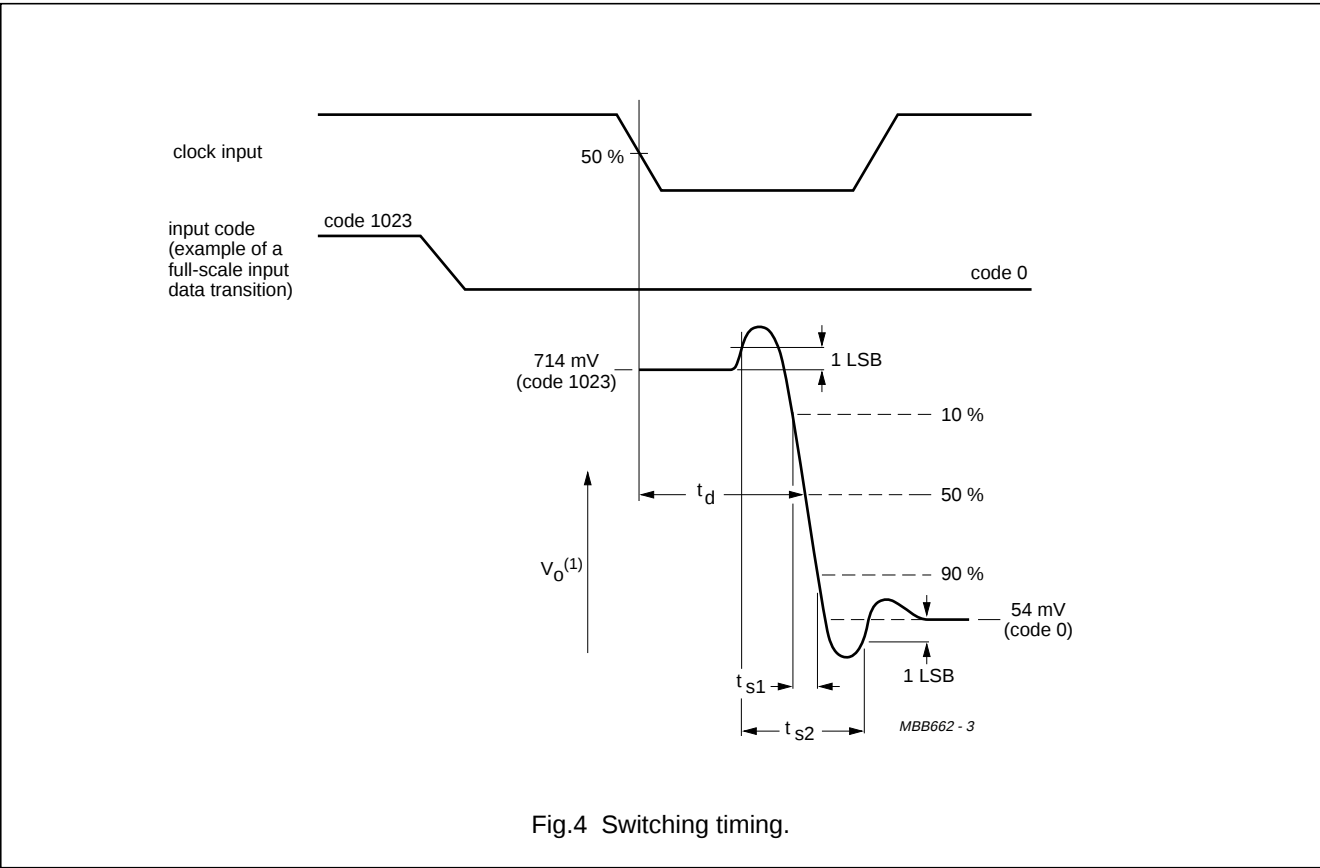
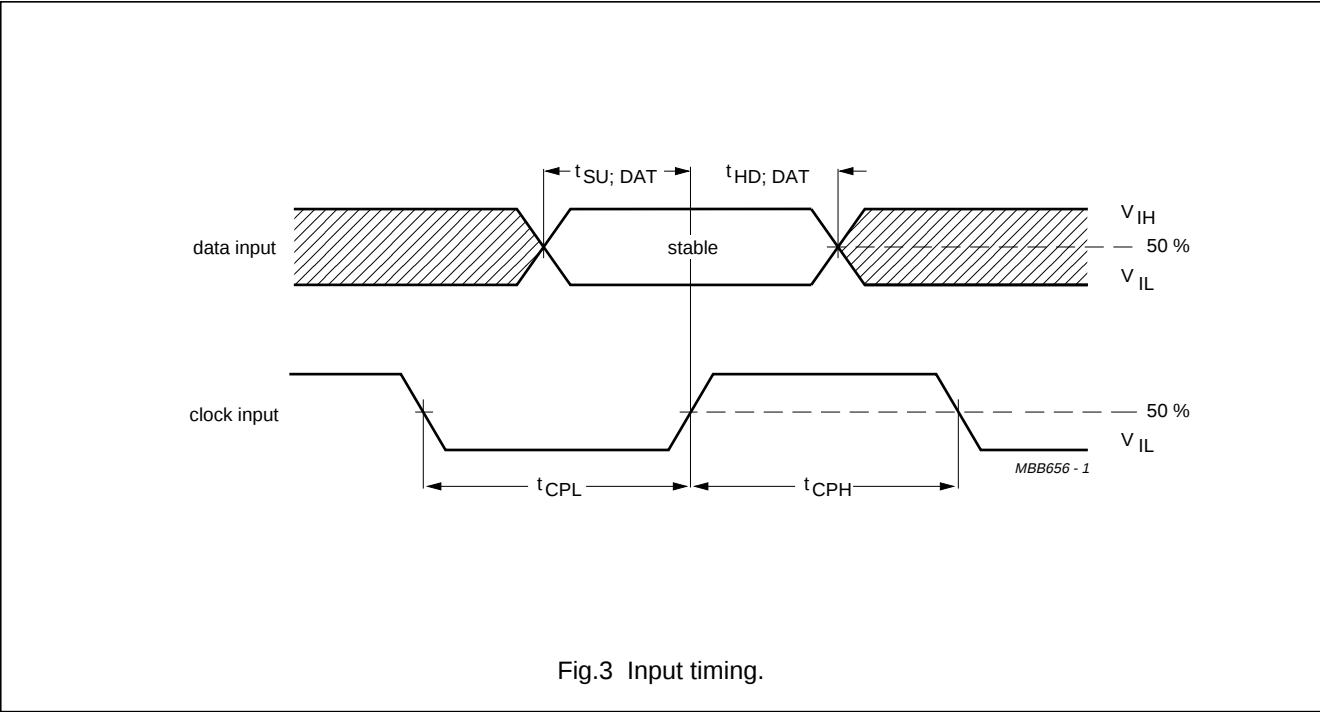
**Table 1** Input coding and DAC output voltages (typical values)

| BINARY INPUT DATA<br>(SYNC = BLANK = 0) | CODE | DAC OUTPUT VOLTAGES (V)<br>OUTB, OUTR, OUTG<br>$R_L = 1 \text{ k}\Omega$ |
|-----------------------------------------|------|--------------------------------------------------------------------------|
| 0000 0000                               | 0    | 0.262                                                                    |
| 0000 0001                               | 1    | 0.273                                                                    |
| .... ....                               | .    | .                                                                        |
| 1000 0000                               | 128  | 1.731                                                                    |
| .... ....                               | .    | .                                                                        |
| 1111 1110                               | 254  | 3.188                                                                    |
| 1111 1111                               | 255  | 3.200                                                                    |

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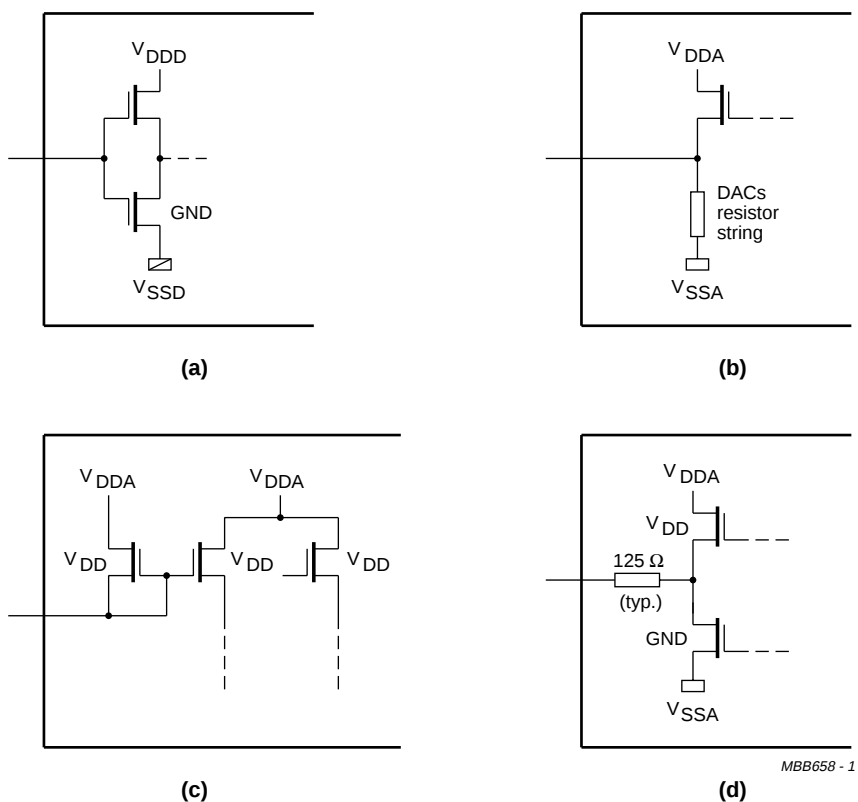
TIMING



# Triple 8-bit video Digital-to-Analog Converter (DAC)

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## INTERNAL CIRCUITRY



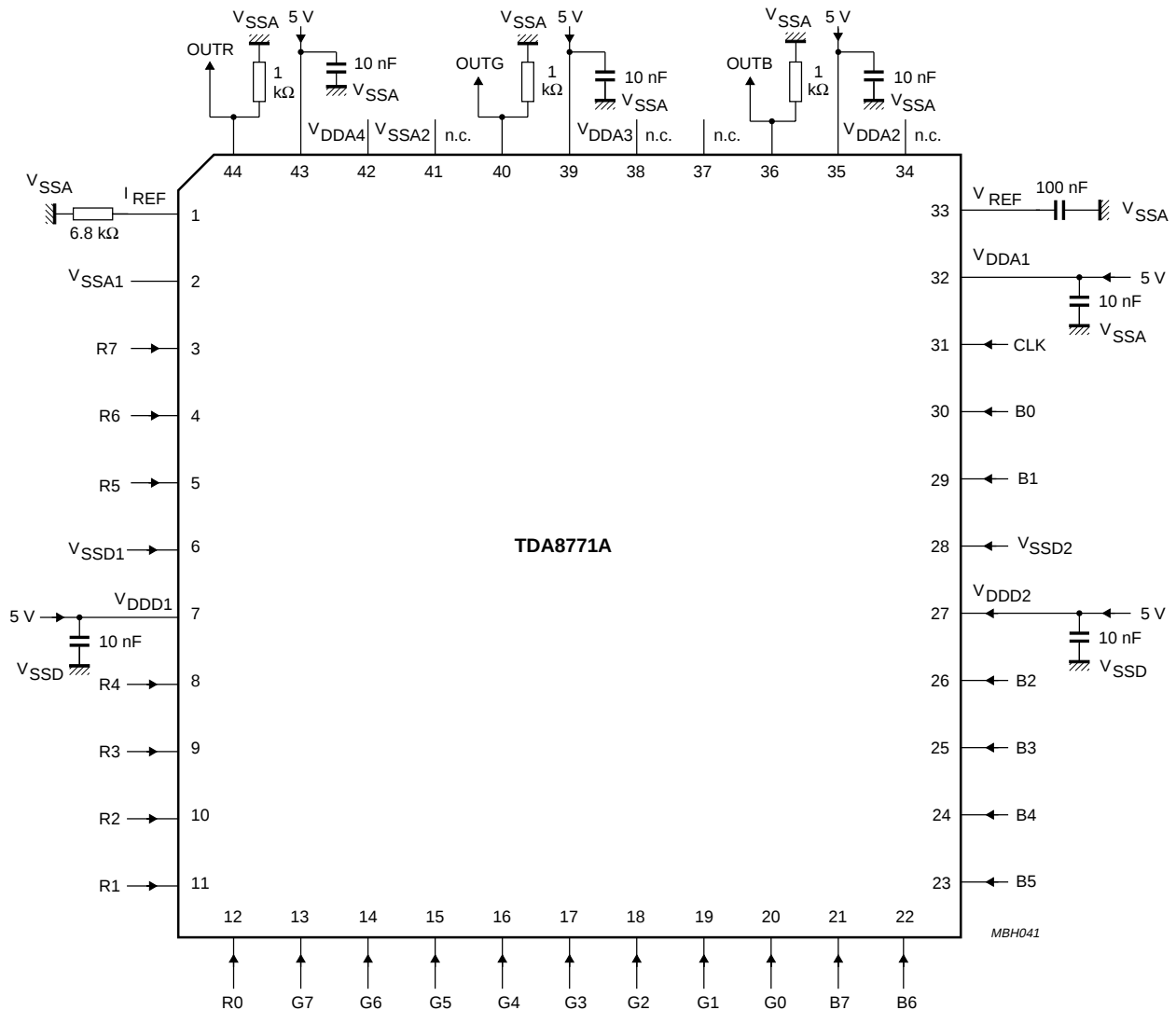
- (a) Digital inputs; pins 3 to 5, 8 to 26 and 29 to 31.  
 (b)  $V_{REF}$ ; pin 33.  
 (c)  $I_{REF}$ ; pin 1.  
 (d) OUTR, G, B; pins 44, 40 and 36.

Fig.5 Internal circuitry.

# Triple 8-bit video Digital-to-Analog Converter (DAC)

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## APPLICATION INFORMATION



Analog and digital supplies should be separated and decoupled.  
 Supplies are not connected internally.  
 All ground pins must be connected. One ground plane is preferred although it depends on application.  
 See Figs 7 and 9 for example of anti-aliasing filter.

Fig.6 Application diagram.

# Triple 8-bit video Digital-to-Analog Converter (DAC)

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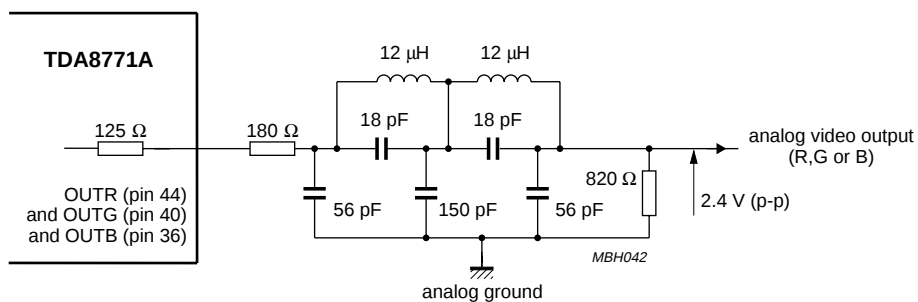


Fig.7 Example of anti-aliasing filter for 2.4 V output swing.

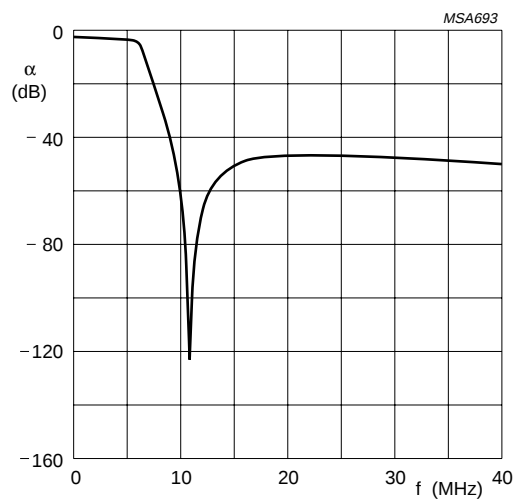


Fig.8 Frequency response for filter shown in Fig.7.

## Characteristics of Fig.8

- Order 5; adapted CHEBYSHEV
- Ripple  $p \geq 0.7$  dB
- $f$  at  $-3$  dB = 6.2 MHz
- $f_{\text{NOTCH}} = 10.8$  MHz.

# Triple 8-bit video Digital-to-Analog Converter (DAC)

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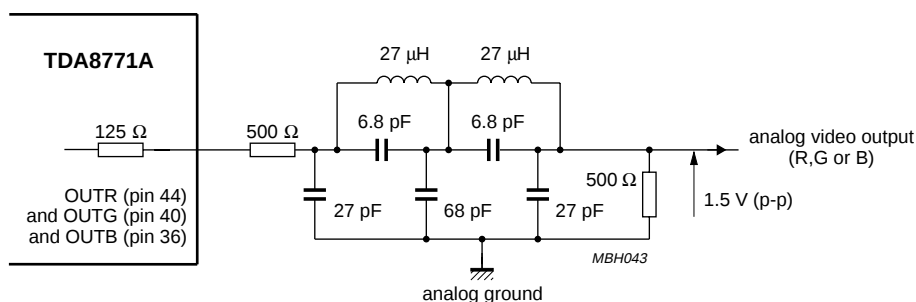


Fig.9 Example of anti-aliasing filter for 1.5 V output swing.

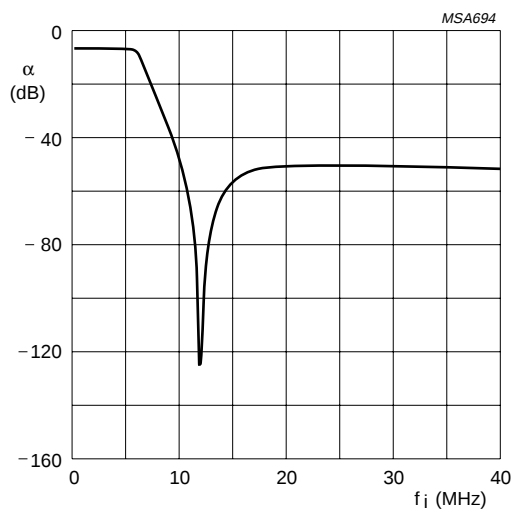


Fig.10 Frequency response for filter shown in Fig.9.

## Characteristics of Fig.10

- Order 5; adapted CHEBYSHEV
- Ripple  $\rho \geq 0.25$  dB
- $f$  at  $-3$  dB = 5.6 MHz
- $f_{\text{NOTCH}} = 11.7$  MHz.

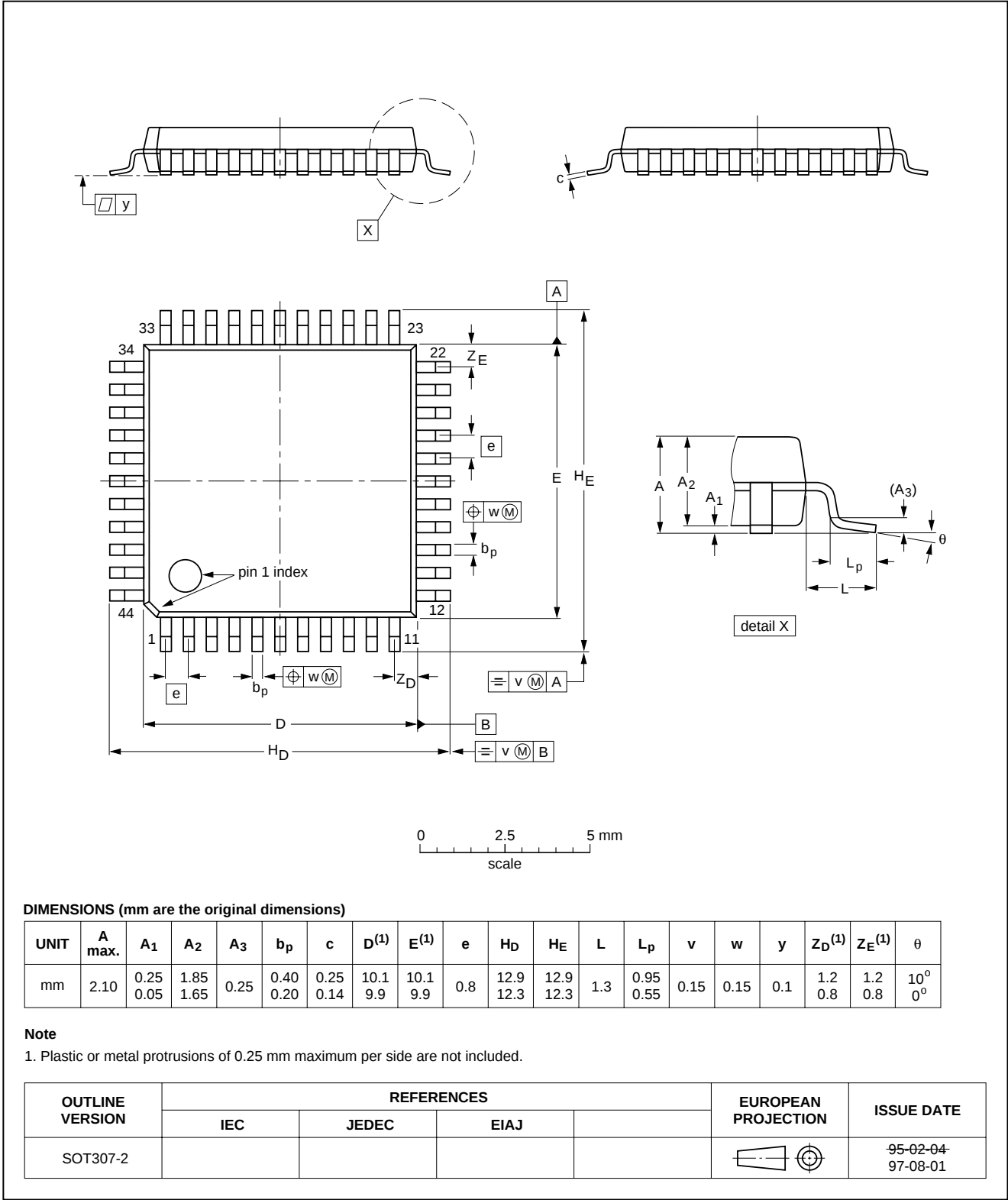
Triple 8-bit video Digital-to-Analog  
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PACKAGE OUTLINE

QFP44: plastic quad flat package; 44 leads (lead length 1.3 mm); body 10 x 10 x 1.75 mm

SOT307-2



## Triple 8-bit video Digital-to-Analog Converter (DAC)

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### SOLDERING

#### Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

#### Reflow soldering

Reflow soldering techniques are suitable for all QFP packages.

The choice of heating method may be influenced by larger plastic QFP packages (44 leads, or more). If infrared or vapour phase heating is used and the large packages are not absolutely dry (less than 0.1% moisture content by weight), vaporization of the small amount of moisture in them can cause cracking of the plastic body. For more information, refer to the Drypack chapter in our *"Quality Reference Handbook"* (order code 9397 750 00192).

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

#### Wave soldering

Wave soldering is **not** recommended for QFP packages. This is because of the likelihood of solder bridging due to closely-spaced leads and the possibility of incomplete solder penetration in multi-lead devices.

**If wave soldering cannot be avoided, the following conditions must be observed:**

- **A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.**
- **The footprint must be at an angle of 45° to the board direction and must incorporate solder thieves downstream and at the side corners.**

**Even with these conditions, do not consider wave soldering the following packages: QFP52 (SOT379-1), QFP100 (SOT317-1), QFP100 (SOT317-2), QFP100 (SOT382-1) or QFP160 (SOT322-1).**

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### Repairing soldered joints

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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**Triple 8-bit video Digital-to-Analog  
Converter (DAC)**

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**TDA8771A**

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**DEFINITIONS**

| <b>Data sheet status</b>                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                                                                       |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                   | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                 | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                     | This data sheet contains final product specifications.                                |
| <b>Limiting values</b>                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                                                       |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |
| <b>Application information</b>                                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                       |                                                                                       |

**LIFE SUPPORT APPLICATIONS**

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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**NOTES**

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**Triple 8-bit video Digital-to-Analog  
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**TDA8771A****NOTES**

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**NOTES**

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